Electronic Patent Application Fee Transmittal						
Application Number:	10646897					
Filing Date:	22-Aug-2003					
Title of Invention:	SEMICONDUCTOR COMPONENT HAVING THINNED DIE WITH CONTACT BUMPS AND POLYMER LAYERS ON SIX SIDES					
First Named Inventor/Applicant Name:	Warren M. Farnworth					
Filer:	Stephen A. Gratton					
Attorney Docket Number:	01-1059.1					
Filed as Large Entity						
Utility Filing Fees						
Description	Fee Code Quantity Amount Sub-Total in USD(\$)					
Basic Filing:						
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Miscellaneous:						
Submission- Information Disclosure Stmt	1806	1	180	180		
	Total in USD (\$)			180		